

IRLI540GPBF-VB Datasheet N-Channel 100-V (D-S) MOSFET

PRODUCT	SUMMARY	
V _{(BR)DSS} (V)	$r_{DS(on)}(\Omega)$	I _D (A)
100	$0.034 \text{ at V}_{GS} = 10 \text{ V}$	50 ^a

FEATURES

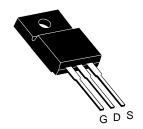
- Trench Power MOSFET
- 175 °C Junction Temperature
- Low Thermal Resistance Package
- 100 % R_g Tested

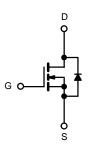
APPLICATIONS

• Isolated DC/DC Converters









N-Channel	MOSFET
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ABSOLUTE MAXIMUM RATINGS	T _C = 25 °C, unless oth	erwise noted		
Parameter		Symbol	Limit	Unit
Drain-Source Voltage		V _{DS}	100	V
Gate-Source Voltage		V _{GS}	± 20	v
Continuous Drain Current (T _{.1} = 175 °C)	T _C = 25 °C	1-	50 ^a	
Continuous Diain Current (1 _J = 175 °C)	T _C = 125 °C	I _D	28 ^a	^
Pulsed Drain Current		I _{DM}	120	A .
Avalanche Current	L = 0.1 mH	I _{AS}	31	
Single Pulse Avalanche Energy ^b	L = 0.1 IIII1	E _{AS}	61	mJ
	T _C = 25 °C	В	360 ^c	10/
Maximum Power Dissipation ^b	T _A = 25 °C ^d	$ P_D$ $-$	3.70	W
Operating Junction and Storage Temperature Ra	nge	T _J , T _{stg}	- 55 to 175	°C

THERMAL RESISTANCE RATINGS	5			
Parameter		Symbol	Limit	Unit
Junction-to-Ambient	PCB Mount (TO-263) ^d	R _{thJA}	40	°C/W
Junction-to-Case (Drain)		R _{thJC}	0.4	C/VV

Notes:

- a. Package limited.
- b. Duty cycle \leq 1 %.
- c. See SOA curve for voltage derating.
- d. When Mounted on 1" square PCB (FR-4 material).

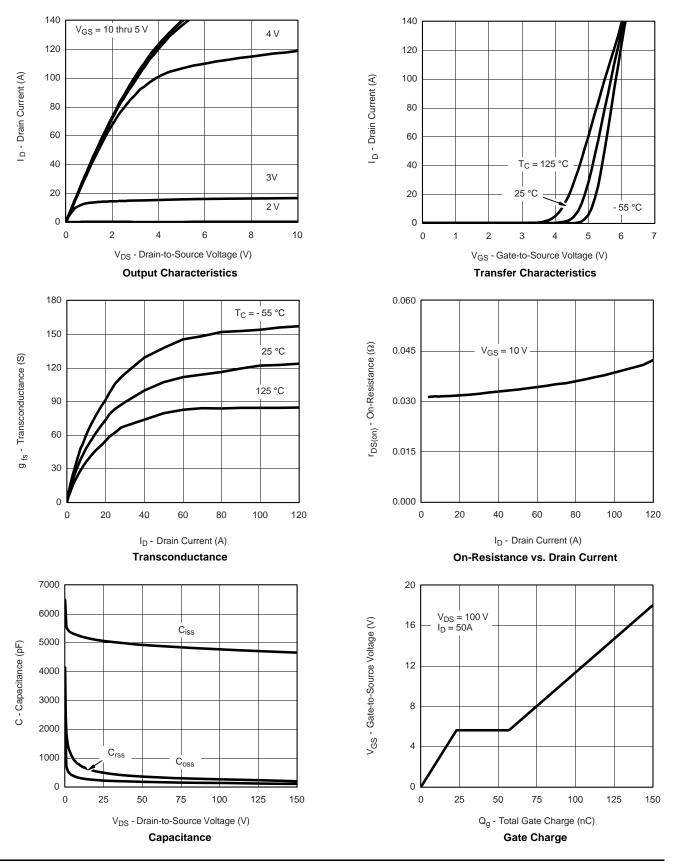


Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{DS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$	100			V	
Gate-Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1.5		2.5	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current		V _{DS} = 100 V, V _{GS} = 0 V			1		
	I _{DSS}	V _{DS} = 100 V, V _{GS} = 0 V, T _J = 125 °C			50	μΑ	
		V _{DS} = 100 V, V _{GS} = 0 V, T _J = 175 °C			250		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	120			Α	
		V _{GS} = 10 V, I _D = 30 A		0.034			
Drain-Source On-State Resistance ^a	r _{DS(on)}	V _{GS} = 10 V, I _D = 30 A, T _J = 125 °C		0.063		Ω	
		$V_{GS} = 10 \text{ V}, I_D = 30 \text{ A}, T_J = 175 ^{\circ}\text{C}$		0.084			
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 30 A	25			S	
Dynamic ^b	•			•			
Input Capacitance	C _{iss}	V _{GS} = 0 V, V _{DS} = 25 V, f = 1 MHz		5100		pF	
Output Capacitance	C _{oss}			480			
Reverse Transfer Capacitance	C _{rss}			210			
Total Gate Charge ^c	Q_g			90	130	nC	
Gate-Source Charge ^c	Q _{gs}	V _{DS} = 100 V, V _{GS} = 10 V, I _D = 65 A		23			
Gate-Drain Charge ^c	Q_{gd}			34			
Gate Resistance	R_{g}		0.5	1.7	3.3	Ω	
Turn-On Delay Time ^c	t _{d(on)}			24	35		
Rise Time ^c	t _r	$V_{DD} = 100 \text{ V}, R_{L} = 1.5 \Omega$		220	330	ns	
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong 65 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 2.5 \Omega$		45	70		
Fall Time ^c	t _f			200	300		
Source-Drain Diode Ratings and Ch	aracteristics 7	T _C = 25 °C ^b					
Continuous Current	I _S			50		۸	
Pulsed Current	I _{SM}			120		A	
Forward Voltage ^a	V_{SD}	I _F = 65 A, V _{GS} = 0 V		1.0	1.5	V	
Reverse Recovery Time	t _{rr}			130	200	ns	
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = 50 A, di/dt = 100 A/μs		8	12	Α	
Reverse Recovery Charge	Q _{rr}			0.52	1.2	μC	

- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %. b. Guaranteed by design, not subject to production testing. c. Independent of operating temperature.

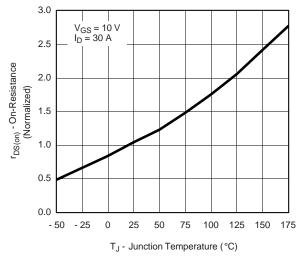


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

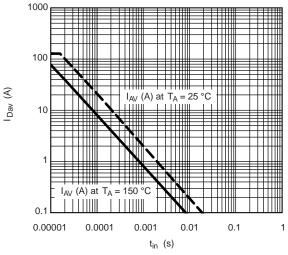




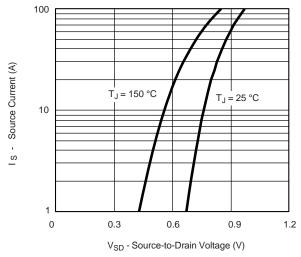
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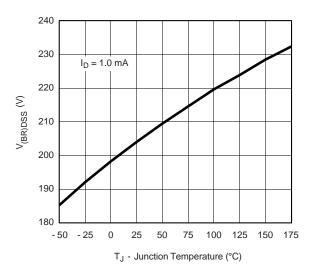
On-Resistance vs. Junction Temperature



Avalanche Current vs. Time



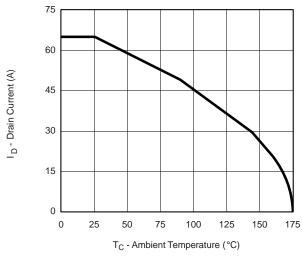
Source-Drain Diode Forward Voltage



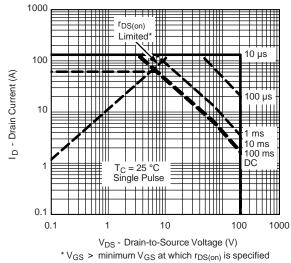
Drain Source Breakdown vs. Junction Temperature



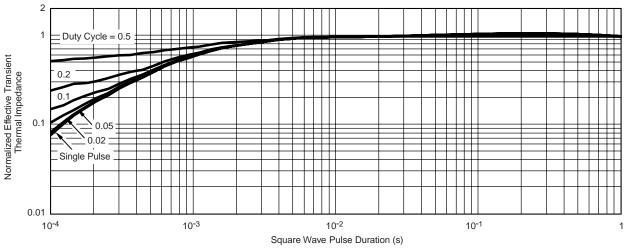
THERMAL RATINGS



Maximum Avalanche and Drain Current vs. Case Temperature



Safe Operating Area

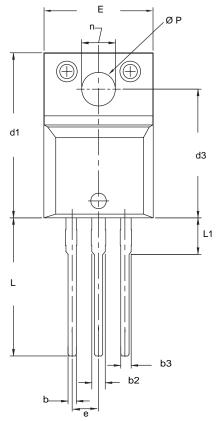


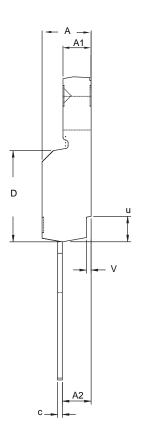
Normalized Thermal Transient Impedance, Junction-to-Case

服务热线:400-655-8788 5



TO-220 FULLPAK (HIGH VOLTAGE)





DIM.	MILLIMETERS		INCHES			
	MIN.	MAX.	MIN.	MAX.		
A	4.570	4.830	0.180	0.190		
A1	2.570	2.830	0.101	0.111		
A2	2.510	2.850	0.099	0.112		
b	0.622	0.890	0.024	0.035		
b2	1.229	1.400	0.048	0.055		
b3	1.229	1.400	0.048	0.055		
С	0.440	0.629	0.017	0.025		
D	8.650	9.800	0.341	0.386		
d1	15.88	16.120	0.622	0.635		
d3	12.300	12.920	0.484	0.509		
E	10.360	10.630	0.408	0.419		
е	2.54	BSC	0.100	0.100 BSC		
L	13.200	13.730	0.520	0.541		
L1	3.100	3.500	0.122	0.138		
n	6.050	6.150	0.238	0.242		
ØΡ	3.050	3.450	0.120	0.136		
u	2.400	2.500	0.094	0.098		
V	0.400	0.500	0.016	0.020		

ECN: X09-0126-Rev. B, 26-Oct-09 DWG: 5972

- To be used only for process drawing.
 These dimensions apply to all TO-220, FULLPAK leadframe versions 3 leads.
 All critical dimensions should C meet C_{pk} > 1.33.
- 4. All dimensions include burrs and plating thickness.
 5. No chipping or package damage.



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